



NO. PINS

PER ROW

(2.54 mm) .100"

**SL, SDL SERIES** 

LEAD

STYLE

PLATING

OPTION

## OW-PROFILE MACHINED SOCKET STR

ΤΥΡΕ

STRIP



Mates with:

BBL, BDL, BHS

TS, TD, HTS, BBS, BBD.

SL

= Single Row Low-Profile Socket Strip

SDL

= Double Row Low-Profile Socket Strip

- Achieve low-profile without sacrificing insertion depth!
- Choice of four precision screw machined lead styles.
- Exceptionally low-profile, down to (2.11 mm) .083" off of board.
- Mates with BBL or BDL for board stacking spaces down to (3.89 mm) .153"

## SPECIFICATIONS

For complete specifications see www.samtec.com?SL or www.samtec.com?SDL

Insulator Material: Black Glass Filled Polyester (SDL) Black Liquid Crystal Polymer (SL) Contact/Shell Materials: BeCu/Brass Plating: Au or Sn over Au of Sin Over 50  $\mu$ " (1.27  $\mu$ m) Ni **Operating Temp Range:** -55 °C to +125 °C with Gold -55 °C to +105 °C with Tin RoHS Compliant:

Yes Lead-Free Solderable: SL: Yes SDL: No, Lead Wave only

## RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



Note:

Some lengths, styles and

options are non-standard, non-returnable.



Unless otherwise approved in writing by Samtec, all parts and components are designed and built according to Samtec's specifications which are subject to change without notice.